

3875081 G E SOLID STATE

UFR Rectifiers

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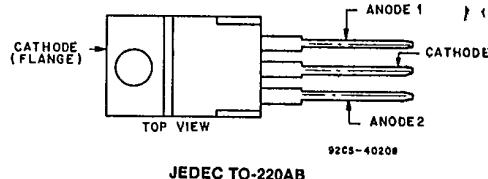
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RUR-D810, RUR-D815, RUR-D820**Ultra High Speed Rectifiers**
RUR-D810 RUR-D815 RUR-D820**Dual 8-A, High-Speed, High Efficiency**
Epitaxial Silicon Rectifiers**Features:**

- Ultra fast recovery time (<35 ns)
- Low forward voltage
- Low thermal resistance
- Planar design
- Wire-bonded construction

Applications:

- General Purpose
- Power switching circuits to 100 kHz
- Full-wave rectification

TERMINAL DESIGNATION

The RCA RUR-D810, RUR-D815, and RUR-D820* are low forward voltage drop ultra fast-recovery rectifiers ($t_{rr} < 35$ ns). They use a glass passivated ion-implanted epitaxial construction.

These devices are intended for use as output rectifiers and fly wheel diodes in a variety of high-frequency pulse-width modulated and switching regulators. Their low stored

charge and attendant fast reverse recovery behavior minimize electrical noise generation and in many circuits markedly reduce the turn-on dissipation of the associated power switching transistors.

All are supplied in TO-220AB plastic packages.

*Formerly RCA Dev. No. TA9224A, TA9224B, and TA9224C, respectively.

MAXIMUM RATINGS, Absolute-Maximum Values, per Junction:

	RUR-D810	RUR-D815	RUR-D820	
VRM	100	150	200	V
IF (Average)				
$T_A = 25^\circ\text{C}$ (No Heat Sink)	3			A
$T_A = 25^\circ\text{C}$ (With Heat Sink)*	8			A
$T_c = 125^\circ\text{C}$	8			A
IFSM (surge)				
8.3ms, 1/2 cycle, non-repetitive	100			A
Tstg, T_j	-55 to 150			$^\circ\text{C}$
T_L (Lead temperature during soldering) At distance > 1/8in. (3.17mm) from case for 10 S max.	260			$^\circ\text{C}$
(a) Wakefield type 295 heat sink with convection cooling				

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RUR-D810, RUR-D815, RUR-D820

ELECTRICAL CHARACTERISTICS, per junction

CHARAC- TERISTICS	TEST CONDITIONS			LIMITS						UNITS	
	T_J °C	Voltage V_R V	Current I_F A	RUR-D810		RUR-D815		RUR-D820			
				Min.	Max.	Min.	Max.	Min.	Max.		
I_R	25	100		—	5	—	—	—	—	μA	
		150		—	—	—	5	—	—		
		200		—	—	—	—	—	5		
	100	100		—	400	—	—	—	—		
		150		—	—	—	400	—	—		
		200		—	—	—	—	—	400		
V_F	25		8	—	0.95	—	0.95	—	1	V	
	100		8	—	0.89	—	0.89	—	0.94		
t_{tr}	25		8(a)	—	35	—	35	—	35	ns	
$R_{\theta JC}$				—	2.25	—	2.25	—	2.25	°C/W	
$R_{\theta JA}$				—	60	—	60	—	60	°C/W	
C_J	25	10	0	40	Typ.	40	Typ.	40	Typ.	pF	

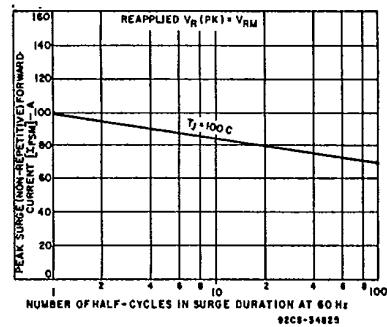
(a) $di/dt > 40A/\mu s$, $I_{RM}(\text{rec}) < 1A$, $I_{RR} = 0.25A$ 

Fig. 1 — Peak surge forward current vs. surge duration.

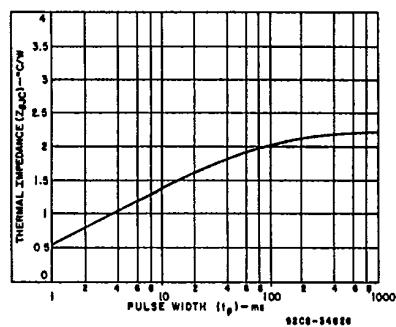


Fig. 2 — Thermal impedance vs. pulse width (per junction).

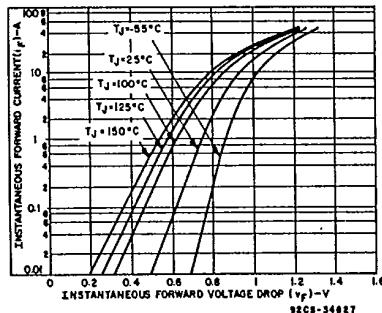


Fig. 3 — Typical forward current vs. forward-voltage drop.

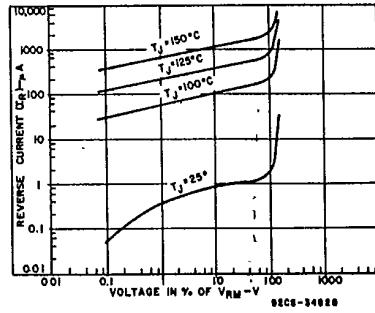


Fig. 4 — Typical reverse current vs. voltage.